Power MOSFET

60 V, 64 m Ω , 17 A, Single N-Channel

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- High Current Capability
- Avalanche Energy Specified
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	60	V
Gate-to-Source Voltage			V_{GS}	±20	V
Continuous Drain Cur-		T _C = 25°C	I _D	17	Α
rent R _{θJC} (Notes 1 & 3)	Steady	T _C = 100°C		12	
Power Dissipation R _{θJC}	State	$T_C = 25^{\circ}C$	P_{D}	49	W
(Note 1)		T _C = 100°C		24	
Continuous Drain Current R _{0.IA} (Notes 1, 2 &		T _A = 25°C	I _D	5.0	Α
3)	Steady	T _A = 100°C		3.0	
Power Dissipation R _{θJA}	State	T _A = 25°C	P_{D}	3.4	W
(Notes 1 & 2)		T _A = 100°C		1.7	
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \mu s$		I _{DM}	71	Α
Current Limited by Package (Note 3)	T _A = 25°C		I _{Dmaxpkg}	30	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	-55 to 175	°C
Source Current (Body Diode)			I _S	41	Α
Single Pulse Drain–to–Source Avalanche Energy (T _J = 25°C, V _{DD} = 30 V, V _{GS} = 10 V, $I_{L(pk)}$ = 9.0 A, L = 1.0 mH, R_G = 25 Ω)			E _{AS}	41	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		TL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Drain)	$R_{\theta JC}$	3.1	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	44	

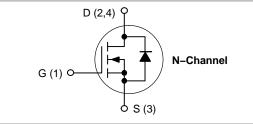
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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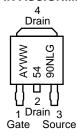
V _{(BR)DSS}	R _{DS(on)}	I _D	
60 V	64 mΩ @ 10 V	17 A	
	85 mΩ @ 4.5 V	17.7	





DPAK CASE 369AA STYLE 2

MARKING DIAGRAMS & PIN ASSIGNMENT



A = Assembly Location*

Y = Year WW = Work Week 5490L = Device Code G = Pb-Free Package

* The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

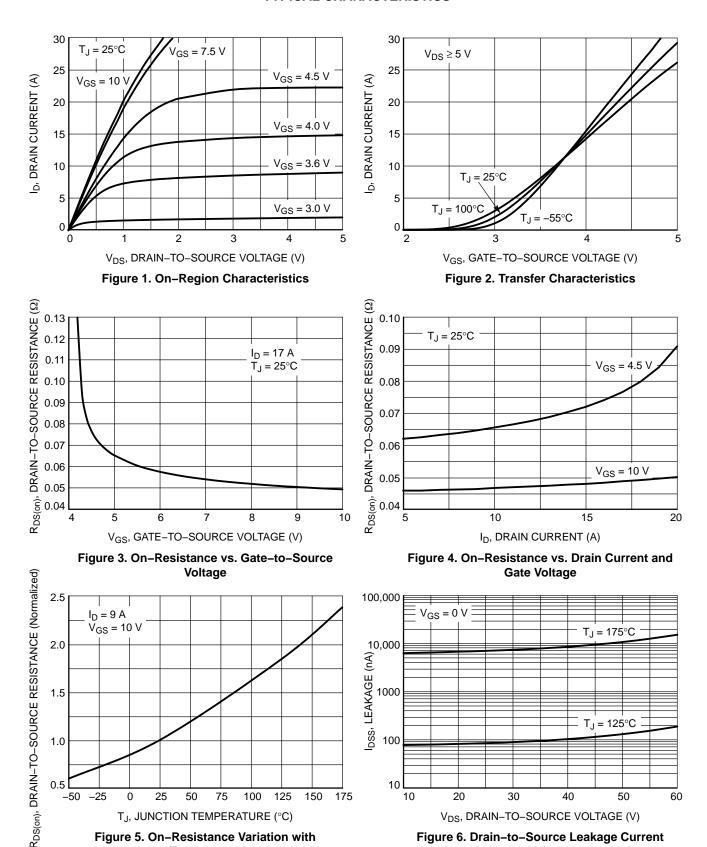
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					-	-	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D =	: 250 μΑ	60			V
Zero Gate Voltage Drain Current			T _J = 25°C			1.0	μΑ
	$V_{DS} = 60 \text{ V}$ $T_{J} = 125^{\circ}\text{C}$	T _J = 125°C			10	1	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS}$	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μΑ	1.5		2.5	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I	_O = 9 A		46	64	mΩ
		V _{GS} = 4.5 V, I	_D = 9 A		66	85	
Forward Transconductance	9FS	V _{DS} = 15 V, I _D	₀ = 20 A		15		S
CHARGES, CAPACITANCES & GATE I	RESISTANCE				-		
Input Capacitance	C _{iss}				365		pF
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V, f} = 0$ $V_{DS} = 25$	1.0 MHz,		91		
Reverse Transfer Capacitance	C _{rss}	VDS - 20			46		
Total Gate Charge	Q _{G(TOT)}	V _{DS} = 48 V,	V _{GS} = 4.5 V		7.8		nC
		$I_D = 9 A$	V _{GS} = 10 V		14]
Threshold Gate Charge	Q _{G(TH)}				0.4		nC
Gate-to-Source Charge	Q _{GS}	V _{DS} = 48 V, I V _{GS} = 10	_D = 9 A		1.5		nC
Gate-to-Drain Charge	Q_{GD}	vGS = 10	,		5.4		nC
Gate Resistance	R_{G}				7		Ω
SWITCHING CHARACTERISTICS (No	te 5)				-		
Turn-On Delay Time	t _{d(on)}				9.4		ns
Rise Time	t _r	Vns = 48 V. Va	s = 4.5 V.		57		1
Turn-Off Delay Time	t _{d(off)}	$V_{DS} = 48 \text{ V}, V_{G}$ $I_{D} = 9 \text{ A}, R_{G}$	= 10 Ω		24]
Fall Time	t _f		•		35		
Turn-On Delay Time	t _{d(on)}				6.7		ns
Rise Time	t _r	$V_{DS} = 48 \text{ V}, V_{G}$	s = 10 V,		17		
Turn-Off Delay Time	t _{d(off)}	$I_D = 9 A, R_G$	= 10 Ω		34		
Fall Time	t _f				34		1
DRAIN-SOURCE DIODE CHARACTER	RISTICS		•				
Forward Diode Voltage		T _J = 25°C		0.97	1.2	V	
		I _S = 9 A T _J = 125°C		0.87		1	
Reverse Recovery Time	t _{rr}	$I_S = 20.5 A_{dc}, V_{GS} = 0 V_{dc},$ $dI_S/dt = 100 A/\mu s$			25		ns
Charge Time	t _a				20		1
Discharge Time	t _b				5.0		1
Reverse Recovery Stored Charge	Q _{RR}				27		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



vs. Voltage

Temperature

TYPICAL CHARACTERISTICS

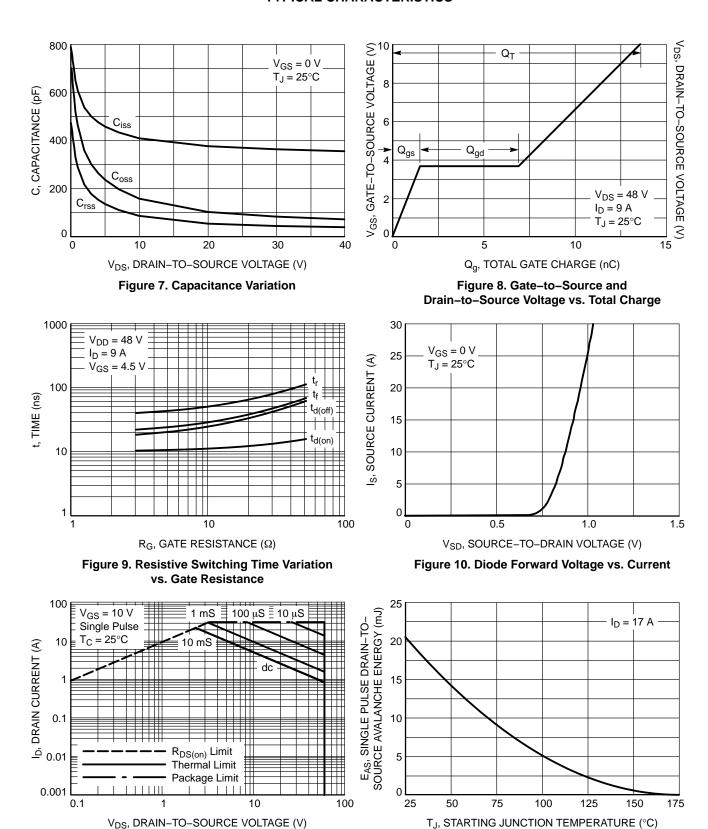


Figure 11. Maximum Rated Forward Biased Safe Operating Area

Figure 12. Maximum Avalanche Energy vs. Starting Junction Temperature

TYPICAL CHARACTERISTICS

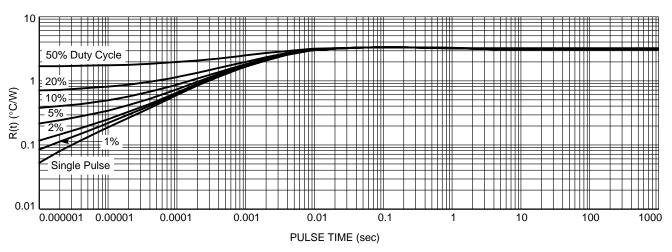


Figure 13. Thermal Response

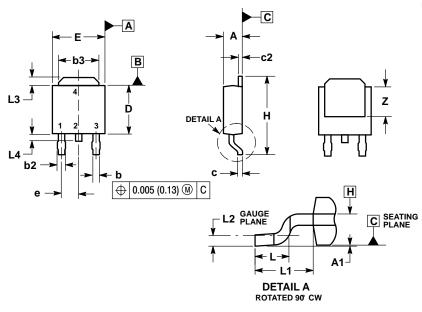
ORDERING INFORMATION

Order Number	Package	Shipping [†]
NVD5490NLT4G	DPAK (Pb-Free)	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

DPAK CASE 369AA ISSUE B



NOTES

- OTES.

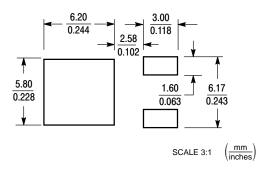
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: INCHES.
- 3. THERMAL PAD CONTOUR OPTIONAL WITHIN DI-MENSIONS b3, L3 and Z.
- MENSIONS D3, L3 and Z.

 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD
 FLASH, PROTRUSIONS, OR BURRS. MOLD
 FLASH, PROTRUSIONS, OR GATE BURRS SHALL
 NOT EXCEED 0.006 INCHES PER SIDE.
- DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.086	0.094	2.18	2.38	
A1	0.000	0.005	0.00	0.13	
b	0.025	0.035	0.63	0.89	
b2	0.030	0.045	0.76	1.14	
b3	0.180	0.215	4.57	5.46	
С	0.018	0.024	0.46	0.61	
c2	0.018	0.024	0.46	0.61	
D	0.235	0.245	5.97	6.22	
Е	0.250	0.265	6.35	6.73	
е	0.090	0.090 BSC		2.29 BSC	
Н	0.370	0.410	9.40	10.41	
L	0.055	0.070	1.40	1.78	
L1	0.108 REF		2.74	REF	
L2	0.020 BSC		0.51	BSC	
L3	0.035	0.050	0.89	1.27	
L4		0.040		1.01	
Z	0.155		3.93		

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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